## **REPAIR REPORTING FORM**

To ensure traceability, you must send back the following information to Sentec by email (<a href="mailto:service@sentec.com">service.us@sentec.com</a> (US only)), if any of the following items is repaired, replaced or updated.

Record the new serial number, the new LOT number and the new hard- and software specific information of the repaired or updated SDM or Sentec TC Sensor (one form per monitor, one form per sensor).

Distributer Information (mandatory)								
Distributor:			Country:					
Contact Person			Distributor's Internal Issue					
(Name, Phone, E-Mail)			Number (if available):					
Product Identification								
Monitor	SN:	S\\/\/a	rsion*: (CMD)	/	MPB/MPL)			
Sensor SN:			SW Version*: (SMB) SW Version*:		(I'II D/I'II L)			
3011301	*after software update (You will fi			nu "System informatio	on".)			
Repair Descri	•							
Short Descrip	tion:							
Short Descrip	11011.							
Description:								
Parts Replaced	1*							
·	Controller Board	E100624	SN	Lot #:				
		E100624		Lot #:				
MPB: Multiparameter Board PCB MPL: Multiparameter Link PCB		E102069		Lot #:				
	Nother Board PCB	E100287		Lot #:				
(S/N < 3200	000)							
SMLM: Mother Board PCB		E102082	SN	Lot #:				
(S/N > 3200	•	E400700	CNI					
	Station Module		SN	Lot #:				
	Station 2 Module		SN	Lot #:				
Display N		E101732 E100385		Lot #: Lot #:				
_	eable Lithium Battery	E100363		Lot #:				
·	Power Supply (S/N < 320000) Power Supply (S/N > 320000)	E100433		Lot #:				
AC/DCF	ower supply (5/11 > 320000)	E102311		LOT#.				
* You will find this information on the labels of the printed circuit boards or on the packing.								
Software Update								
Form completed								
	All required function and performance tests were successfully  SUBMIT BY EMAIL							
passed (as defined in HB-005615, HB-006815, HB-006568)								
Date (YYYY-MM-DD):								



CH-4106 Therwil Switzerland



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For Sentec Use only								
Complaint?  no	Reason:							
☐ yes	Complaint Record CR #							
Section completed by:								
Date		Signature:						
(YYYY-MM-DD):								